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Chapter 1. Target Devices

The target devices supported by the CS+ are listed on the Website.
Please see this URL.
CS+ Product Page

<https://www.renesas.com/cs+>

Chapter 2. User's Manuals

Please read the following user's manuals along with this document.

Manual Name	Document Number
CS+ V8.02.00 Installer	R20UT4525EJ0100
CS+ V8.04.00 Editor	R20UT4688EJ0100
CS+ V8.05.00 Python Console	R20UT4854EJ0100
CS+ V5.00.00 Updater	R20UT3942EJ0100
CS+ V8.05.00 Message	R20UT4855EJ0100
CS+ V8.05.00 Project Operation	R20UT4856EJ0100
CS+ V8.01.00 Analysis Tool	R20UT4406EJ0100
CS+ V8.05.00 RH850 Debug Tool	R20UT4858EJ0100
CS+ V8.03.00 RX Debug Tool	R20UT4588EJ0100
CS+ V8.05.00 RL78 Debug Tool	R20UT4857EJ0100
CS+ V8.05.00 GHS CCRH850 Build Tool Operation	R20UT4853EJ0100

* GHS: Green Hills Software, LLC

Chapter 3. Uninstallation

There are two ways to uninstall this product.

- Use the integrated uninstaller from Renesas (uninstalls all CS+ components)
- Use the Windows uninstaller (only uninstalls this product)

To use the Windows uninstaller, select [CS+ for CC] from [Apps & features] from [Settings] of Windows or [Programs and Features] of the control panel.

Chapter 4. Improvements and changes

This chapter describes changes from V8.04.00 to V8.05.00.

4.1 Additions and improvements to the build tool

4.1.1 Enhanced support for Renesas compilers [RL78] [RH850] [RX]

Support for the following versions of compilers has been added.

- CC-RL V1.10.00
- CC-RH V2.03.00
- CC-RX V3.03.00

4.1.2 Enhanced support for GHS compilers [RH850]

Support for the following versions of the RH850 compiler from GHS has been added.

- 2020.5.5

4.1.3 Improved performance for the facility of using the compiler to update file dependencies

Enabling the [Use compiler for updating dependencies to increase analysis accuracy than analysis speed when the functionality is available] option for the [General – Build] category in the [Option] dialog box improves performance in updating dependencies. This improved the time for a first build by 30%*.

*: This was the case for a source file provided by Renesas.

4.1.4 Improved handling of section settings after the MCU has been changed

Handling of the inheritance of section settings when the MCU is changed, a project for the e² studio is converted to one for CS+, or the reuse of the file structure of an existing project in creating a new project, with the result of the microcontroller name for the new device being such that the ROM size differs from that of the device which was previously selected, and the section settings had been customized in the original project, has been improved.

Before the improvement: The section settings were initialized according to the microcontroller name of the new device following the change.

After the improvement: The section settings which had been customized before the change of device are inherited.

Note that some addresses in the section settings are converted to those for the microcontroller name of the selected device.

4.1.5 Improved the link order after converting a project from e² studio

When converting a project from e² studio as follows, the link order of the intermediate file (*.obj file) has been improved to match the source project.

Occurrence condition: e² studio project with multiple source files of the same name

Improved link order: Intermediate file (*.obj file) link order from source file with same name file

4.1.6 Improved building after specifying the output of division hexadecimal files

Improved build error when building after having specified an entry in the format "*<file name>=<section name>:<section name>[:<section name>..]/<load address>*" for the [Division output file] property on the [Hex Output Options] tabbed page.

4.2 Additions and improvements to the debug tool

The abbreviations listed below collectively denote the corresponding tools in this section.

OCD (serial):

Serial or FINE interface connection for the E1 emulator, E20 emulator, E2 emulator, and E2 emulator Lite

OCD (JTAG):

JTAG interface connection for the E1 emulator, E20 emulator, E2 emulator, and E2 emulator Lite

OCD (LPD):

LPD connection for the E1 emulator, E20 emulator, and E2 emulator

4.2.1 Enhanced support for GHS compilers [RH850]

Support for the following versions of the RH850 compiler from GHS has been added.

- 2020.5.5

4.2.2 Addition of a tracing facility for the GTM [RH850]

The GTM is now within the scope of tracing.

4.2.3 Improvement to the operation when using the E2 emulator with RL78 family devices [RL78]

Previously, if a break occurred during self-programming, the debugger would hang and disable continued debugging. This problem has been rectified.

For details on restrictions applicable to this item, refer to the following URL.

<https://www.renesas.com/document/tnn/notes-chip-debugging-emulator-e2-emulator-0>

4.2.4 Improvement to the operation when using the E2 emulator with RL78 family devices [RL78]

If a run time was measured by run-break timer events, the measured value would include an error of up to 100 msec. This error has been eliminated.

For details on restrictions applicable to this item, refer to the following URL.

<https://www.renesas.com/document/tnn/notes-chip-debugging-emulator-e2-emulator-1>

4.2.5 Addition of types of components supported on the [Virtual Board] panel [RL78]

Applies to: Simulator for RL78/G10, RL78/G11, RL78/G12, RL78/G13, RL78/G13A, RL78/G14, RL78/L12, and RL78/G1F

Support for the following types of component has been added to the [Virtual Board] panel.

- Brushless DC motor, analog input switch, and detailed waveform monitor

4.2.6 Improvement to the real-time updating of the Watch panel

An event having been set would sometimes delay the real-time updating of the Watch panel. Such delays have been reduced.

4.2.7 Improvement to the operation of the peripheral simulation facility in terms of the display of received data in the [Serial] window [RL78]

Applies to: Simulator for RL78/G10, RL78/G11, RL78/G12, RL78/G13, RL78/G13A, RL78/G14, RL78/L12, and RL78/G1F

In the simulator, when UART transmission proceeded with the 7-bit data length and MSB first from an RL78 MCU, the received data displayed in the [Serial] window which is opened from the [Simulator GUI] window were shifted by one bit to the left. This problem has been rectified so that the display of received data is correct.

4.2.8 Improvement to the operation in response to a property of the temperature sensor on the [Virtual Board] panel [RL78]

Applies to: Simulator for RL78/G10, RL78/G11, RL78/G12, RL78/G13, RL78/G13A, RL78/G14, RL78/L12, and RL78/G1F

When the property of the initial input value for the temperature sensor was set on the [Virtual Board] panel, specifying the value at the top of the drop-down list was not possible if the drop-down list did not include the current setting value for the initial input value. This problem has been corrected so that the value at the top of the drop-down list is now specifiable.

4.2.9 Improvement to the operation in response to an error regarding properties of the temperature sensor on the [Virtual Board] panel [RL78]

Applies to: Simulator for RL78/G10, RL78/G11, RL78/G12, RL78/G13, RL78/G13A, RL78/G14, RL78/L12, and RL78/G1F

The values set for the [Conversion Factor] and [Conversion Offset] properties of the temperature sensor on the [Virtual Board] panel are used in converting the temperature to the corresponding voltage. The behavior when a result of conversion thus obtained is out of the input range of values for the connected pin has been improved so that the voltage is automatically corrected.

The converted value is corrected to be the minimum value within the input range if it is less than the minimum voltage and to be the maximum value if it is greater than the maximum voltage.

4.2.10 Improvement to the operation in response to the properties of the 8x8-segment LCD for use with the on-chip driver on the [Virtual Board] panel [RL78]

Applies to: Simulator for RL78/L12

While the input screen is being displayed during editing of the COM/SEG signal properties of the 8x8-segment LCD for use with the on-chip driver on the [Virtual Board] panel, operation has been improved by de-activating the [OK] button for the settings if a program is run.

4.3 Improvements to the Python console

4.3.1 Addition of a detailed information, and point for caution regarding Python functions

The following detailed information, and point for caution for Python functions have been added.

Function Name	Newly Added Information	Description
debugger.Memory.Read	Detailed information	Information on the processing time for reading was included.
debugger.Memory.Write	Detailed information	Information on the processing time for writing was included.
debugger.Reset	Point for caution	A point for caution on the operation after a reset is issued was added.

4.4 Addition and improvement to the facilities for measuring current drawn [RL78] [RX]

Applies to: Simulator (RL78) and E2 emulator (RL78 and RX)

4.4.1 Extension of the zoom percentage of the [Measuring Current Consumption] panel

The range of zoom percentages for the [Measuring Current Consumption] panel has been considerably extended to a maximum of 60,000%, enabling more detailed confirmation of the transitions in current drawn.

Chapter 5. Points for Caution

This section describes points for caution regarding CS+.

5.1 Points for caution regarding CS+ (general)

5.1.1 File names

The following rules apply to folder and file names.

- Folder and file names
 - Do not use folder or file names that cannot be created from Windows Explorer.
 - Network path names cannot be used. Include the drive names to which paths are allocated.
- Source file names, load module file names, and project file names
 - File names consist of the characters a-z, A-Z, 0-9, the period (.), the underscore (_), plus sign (+), and minus sign (-).
 - File names cannot start or end with a period (.
 - File names cannot start with a plus sign (+) or minus sign (-).
 - CS+ is not case-sensitive to file names.
 - File names may have up to 259 characters, including the path.
 - Do not use source files with the same file name. Even if they are on different paths, CS+ cannot classify them.
- File names other than the above
 - File names comply with Windows conventions.
 - Note that the following characters cannot be used in file names.
\\ : * ? " < > | ;
 - File names cannot start or end with a period (.) or space.
 - CS+ is not case-sensitive to file names.
 - File names may have up to 259 characters, including the path.
- Folder names
 - Folder names comply with Windows conventions.
 - Note that the characters below cannot be used in file names.
() , =

5.1.2 Panel display

If your hardware environment does not meet the recommended specifications for CS+, the [Property] panel may appear small and have scrambled contents.

If this happens, move the [Property] panel outside the split panel area.

- Enable [Dockable], and make it a docking panel
- Enable [Floating], and make it a floating panel

5.1.3 Problem with a Windows update program

Depending on the Windows update program, starting the CS + for CC in Windows 8.1 may cause an error or the PC to crash.

In this case, do any of the followings.

- install the latest VC++ 2015 runtime (x86 version)
- apply the latest Windows update program

5.1.4 [Editor] panel

- When a variable or label is selected and the Jump to Function feature is used from the context menu, execution does not jump to the variable or label.
- The following notes apply to the editor, when source files with the same name but from different folders are registered with a main project and a sub project, and load modules from both the main project and sub project are downloaded.
 - The address of the main project is displayed on the file.
 - At jumping to a source file from disassembled code, the file registered with the main project is opened.
 - If the file is opened from either project, only one file will be opened.

- On Windows 8.1 and Windows 10, the display may become unclear due to anti-aliasing.
- When saving a file in the [Save As] dialog box, the extension listed at the top of the [Save as type] drop-down list is automatically added unless another extension is specified. Note however, that an extension is not added when a file name is input with an extension that is selected in the [Save as type] drop-down list or with an extension that is registered with Windows. When an automatically added extension is not as expected, modify the name of the file by using, for example, Explorer.
- Printing the contents of the Editor panel is not possible in an environment with .NET Framework 4.6 installed. To do so in that case, use an editor other than that of CS+.

5.1.5 Creating new projects

Applies to: RX

If a new project is created by selecting [Empty Application[CC-RX]] under the environment for the RX, building the project may lead to the following errors.

- ** L2132 (E) Cannot find "D" specified in option "rom"
- ** L2132 (E) Cannot find "D_1" specified in option "rom"
- ** L2132 (E) Cannot find "D_2" specified in option "rom"

If you encounter these errors, change the setting of [ROM to RAM mapped section] on the [Link Options] sheet in CS+.

5.1.6 Tutorials

The Code Generator Plug-in, Pin Configurator Plug-in and Program Analyzer Plug-in are used in tutorials. Enable them through the [Plug-in Manager] dialog box.

5.1.7 Starting multiple instances of CS+

Two or more instances of CS+ can be started on the same host machine, but if you do so, take note of the points listed below.

- When two or more instances of CS+ are started, the most recent information to have been written is saved in the information file for each user's own PC.
- When two or more instances of CS+ are started, the most recent information to have been written is saved in the information file for the stack analysis tools (including CallWalker).
- When the same project file is used in two or more instances of CS+, the most recent information to have been written is saved.
- When the same project file is used in two or more instances of CS+, do not attempt building from more than one instance at the same time since the names of the output files will be identical.

5.1.8 Loading projects by using earlier versions of CS+

If the version of CS+ being used to load a project is earlier than the CS+ version with which the project was created, some settings may be cleared since the earlier versions of CS+ do not recognize them.

5.1.9 .NET Framework from Microsoft Corporation

CS+ outputs the following message and is closed if the version of the .NET Framework you are using is earlier than 4.5.2.

E0200010

Failed to launch this product.

Please install the Microsoft .NET Framework 4.5.2 or later on this PC.

In such cases, obtain version 4.5.2 or a later version of the .NET Framework from the Web page of Microsoft Corporation and install it before starting up CS+ for CC.

Note that the update manager for CS+ for CC is not usable for updating the .NET Framework.

5.1.10 Dual-bank function of the code flash memory

Applies to: RX65N/RX651-2M Group

Products of the RX65N and RX651 groups with 2 or 1.5 MB of ROM support the dual-bank function of the code flash memory. In CS+, you can select the linear or dual mode during the process of setting up a project.

In use of dual mode, select the type name with "_DUAL".

5.1.11 Smart Manual

Applies to: RX, RL78

When the Smart Manual does not support the target MCU of an open project, the user's manuals are not displayed.

5.1.12 CS+ Partner OS Aware Debugging Plug-in

Applies to: RL78, RX

When CS+ is started with the CS+ Partner OS Aware Debugging Plug-in enabled and by using CubeSuite+.exe (without the Main window), the error message "(0202002) Opening a project failed." is returned.

This can be avoided in either of the following ways.

- Start CS+ by specifying an option to prevent reading of the CS+ Partner OS Aware Debugging Plug-in for CubeSuite+.exe.
Example: CubeSuite+.exe /np PartnerOS ...
- Turn off the CS+ Partner OS Aware Debugging Plug-in before starting CS+ with CubeSuite+.exe (without the Main window).

How to turn off the plug-in:

Start CS+ (with the Main window) or CubeSuite+ (CubeSuiteW+.exe).

Select [Plug-in Setting...] from the [Tool] menu to display the [Plug-in Manager] dialog box.

Deselect the [CS+ Partner OS Aware Debugging Plug-in] checkbox.

5.1.13 RX72M

When creating a new RX72M project, there are differences between the register definition contents of iodefine.h and the contents of the RX72M User's Manual.

Applicable iodefine.h file version is V1.00A and earlier.

1. Error : unsigned short ACKCMDER:1;
Correct : unsigned short ACKCMDERR:1;
2. Error : unsigned long PSADR:19;
Correct : unsigned long PSADR:17;

5.1.14 Mentions of "R8C" in user's manuals and online help

"R8C" is mentioned in the user's manuals and online help, but CS+ does not support the R8C family.

5.2 Points for caution regarding build tools

5.2.1 Build option import

Build option import fails if setting the value of "Select modules which are output in files" property in the "I/O Header File Generation Options" tab in Build tool property to "Yes" in the project in import destination/source and importing.

Set the value of "Select modules which are output in files" property to "No" in the project of the import destination, and save the project. Then, import the build option after opening the project again.

5.2.2 Build mode

In the [Build Mode Settings] dialog box, the build mode can be duplicated or renamed with different names in terms of upper- and lower-case letters from those of the existing name of the build mode.

Usually, the name of a build mode is that which has been specified for the [Intermediate file output folder] property on the [Common Options] tabbed page of the [Property] panel of the build tool or that which has been specified for the [Output folder] property on the [Link Options] tabbed page or [Hex Output Options] tabbed page. Note that the output destinations of two build modes having names that differ in terms of upper- and lower-case letters will be the same unless the following step is taken. Avoid this problem by specifying different folder names for the [Intermediate file output folder] and [Output folder] properties.

5.2.3 Updating file dependencies

When the [Use compiler for updating dependencies to increase analysis accuracy than analysis speed when the functionality is available] option is enabled for the [General – Build] category in the [Option] dialog box, if a source file is added to the project tree and building then proceeds, the source file is re-compiled regardless of whether or not the source file have been updated.

To avoid this problem, select [Update Dependencies] from the [Build] menu, or, save the project, close it, and then re-open it.

5.2.4 Project conversion from e² studio [RL78]

On the project conversion from e² studio, the settings of [Hex Output Options] tab may not take over in the second and subsequent build modes.

Workaround : After project conversion, set the [Hex Output Options] tab.

5.3 Points for caution regarding design tools

5.3.1 Saving projects

If you save a project that has sub-projects while the [Device Top View] or [Device Pin List] panel is open, then the device top view and device pin list of the main project will always appear.

5.3.2 Displaying Find and Replace dialog box

The position of the Find and Replace dialog box is remembered and restored. In a multi-display environment, for example, in case that the sub display is temporarily OFF, the Find and Replace dialog box may not appear due to being off the screen.

In the case, it is possible to move to the visible position in the following way:

1. Immediately after entering Ctrl+F, in other word, with the focus on the Find and Replace dialog box, enter the Alt+Spacebar. The control menu will appear, enter the M key to select [M]ove].
2. Enter the arrow keys in that state, or move the mouse cursor to display the dialog.

5.4 Points for caution regarding debugging tools

The abbreviations listed below collectively denote the corresponding tools in this section.

OCD (serial): E1 Emulator (serial), E20 Emulator (serial)

OCD (JTAG): E1 Emulator (JTAG), E20 Emulator (JTAG)

5.4.1 Adding sub-projects

Applies to: Common to all debugging tools and devices

If you add a sub-project while a debugging tool is connected, downloading and so on may fail. Only add sub-projects while the debugging tool is disconnected.

5.4.2 Assigning unions to registers

Applies to: All debugging tools for RX

When a union is assigned to a register, it is assumed that the members of the union are assigned to the lower-order bytes of the register. For this reason, the values of the members will be incorrect when displayed as big endian.

5.4.3 Functions with the same name and char-type parameters

Applies to: All debugging tools for RX

When three functions with char-type parameters are defined as shown below, the address of "Func(signed char)" will not be displayed (i.e. the address of "Func(char)" will be displayed instead).

```
void Func(char);  
void Func(signed char);  
void Func(unsigned char);
```

5.4.4 Changing the priority section among overlaid sections

Applies to: All debugging tools for RX

Changing the priority section among overlaid sections is not immediately reflected in debugger operations. To update the display of addresses in the editor, for example, you need to close the file and open it again. To update the display of variables in the [Watch] panel, execute a single step of the program.

5.4.5 Linkage options of CC-RX

Applies to: All debugging tools for RX

CC-RX does not support the '-sdebug' linkage option.

Please set [Outputs debugging information] in the [output] category of the [Link Options] tabbed page to '-debug'.

5.4.6 Breakpoints in for statements or inline-expanded functions

Applies to: All debugging tools for all devices

If a line of C source code includes any of the functions or statements listed below, the instruction is placed at two or more addresses. However, the editor panel shows only one of the addresses.

In cases where a breakpoint is set on this line, the program stops only when the instruction at the address being displayed on the editor panel is executed.

1. Inline-expanded function (*)
 2. Template function
 3. First line of a for or do-while statement
- * Includes those inline-expanded by optimization

5.4.7 Notice of the project of dual mode

Applies to: All debugging tools for RX65N-2M, RX651-2M group

In case of a project of a dual mode of a device with less than 1.5 MB of ROM size, a gap exists during the address of the ROM in bank 0 and bank 1.

But data in a gap exists in the following function.

- Memory panel
- Watch panel
- Disassemble panel

[E1/E20/E2/E2Lite]

Read result is 0x00, Write is ignored.

[Simulator]

Read and Write operate correctly.

5.4.8 Notice regarding the IE850A

Applies to: IE850A for RH850

Values larger than 512 K can be specified for the [Trace memory size [frames]] property. If such values are specified, however, only the latest 512 Kbytes of trace data will be used in the display of the [Trace] panel and in the Python console.

5.4.9 Notice regarding the RL78/G1M, RL78/G1N

Applies to: OCD(Serial) for RL78/G1M, RL78/G1N

The following properties cannot be used with RL78/G1M and RL78/G1N.

Connect Setting - Connection with Target Board - Low voltage OCD board

5.4.10 Simulation of peripheral modules

Applies to: Simulator for RL78/G10, RL78/G11, RL78/G12, RL78/G13, RL78/G13A, RL78/G14, RL78/L12, and RL78/G1F

Operation of CS+ may be incorrect if the user program or a debugging operation makes settings of the SFR which are prohibited in the user's manual for the target device.

5.4.11 Point for caution on time measurement by the simulator when the device is in standby mode

Applies to: Simulator for RL78, RH850

When the program is on standby (in halt, stop, or snooze mode for an RL78 device and in halt mode for an RH850 device), time measurement by the following facilities does not operate correctly.

(1) Run-break timer facility (for RL78 simulator and RH850 simulator)

The run-break time is not correctly measured in the following cases.

- A forced break occurred in standby mode.
- A program is run following standby mode (run after a forced break).

(2) The Python function debugger.Interrupt.SetTimer (only for the RH850 simulator)

Even if the break time specified with debugger.Interrupt.SetTimer is matched on standby (in halt mode), the break does not occur until the program is released from standby.

This also applies in cases when the break time was specified with debugger.XRumBreak.Set since it is based on the same functionality.

5.4.12 Setting of the [Serial] window opened from the [Simulator GUI] window

Applies to: Simulator for RL78/G10, RL78/G11, RL78/G12, RL78/G13, RL78/G13A, RL78/G14, RL78/L12, and RL78/G1F

When you use the [Serial] window to simulate UART communications after having opened it from the [Simulator GUI] window, specify the value (with the fractional part of a resulting floating-point number rounded up) which was calculated from the expression for calculating the baud rate of the target device for [Baudrate] in the [Format (UART)] dialog box.

5.4.13 Simulation of the reset control flag register (RESF)

Applies to: Simulator for RL78/G10, RL78/G11, RL78/G12, RL78/G13, RL78/G13A, RL78/G14, RL78/L12, and RL78/G1F

The reset control flag register (RESF) of the target device is automatically cleared if it is read by an 8-bit memory manipulation instruction; however, this does not clear the register in the case of the simulator.

Chapter 6. Restrictions

This section describes restrictions on CS+.

6.1 Restrictions imposed by debugging tools

The abbreviations listed below collectively denote the corresponding tools in this section.

OCD (serial):

Serial or FINE interface connection for the E1 emulator, E20 emulator, E2 emulator, and E2 emulator Lite

OCD (JTAG):

JTAG interface connection for the E1 emulator, E20 emulator, E2 emulator, and E2 emulator Lite

OCD (LPD):

LPD connection for the E1 emulator, E20 emulator, and E2 emulator

6.1.1 List of restrictions imposed by debugging tools

No.	Target tool	Target device	Description	Remarks
1	All debugging tools	RL78, RX, RH850	Division of load modules	
2	All debugging tools	RL78, RX, RH850	Display of information on variables	
3	All debugging tools	RL78, RX, RH850	Source files with the same name	

6.1.2 Details of restrictions imposed by debugging tools

No.1 Division of load modules

Applies to: All debugging tools for RL78, RX, RH850

Description: The restrictions below apply when the CC-RH compiler is used to generate split load modules from a program.

- a. Source-level debugging becomes impossible.
- b. The second and subsequent output files are not automatically registered with the debugging tool.

Workaround: There is no workaround.

No.2 Display of information on variables

Applies to: All debugging tools for RL78, RX, RH850

Description: If two or more variables defined in a function have the same name, the values of variables that can be viewed when the program has stopped may differ from the expected values. Whether this phenomenon arises depends on the optimization level* selected during the process of compilation.

Note: The optimization level can be set via [Build Tool] – [Common Options] – [Frequently Used Options (Link)].

[Example] In the example below, char-type variable “a” is in the innermost scope at (*1) and int-type variable “a” is in the innermost scope at (*2). Under some conditions, however, only the value of one of the variables will be visible at (*1) and (*2).

```
void main()
{
    int a = 100;
    {
        char a = 'A';
        a++; <-( *1)
    }
    a++; <-( *2)
}
```

- Display of (*1) in the [Watch] panel
 - “a” ‘A’ (0x41) “signed char” “0xfefb1004” // Expected value
 - or “a” 100 (0x00000064) “int” “0xfefb1000”
- Display of (*2) in the [Watch] panel
 - “a” ‘B’ (0x42) “signed char” “0xfefb1004”
 - or “a” 100 (0x00000064) “int” “0xfefb1000” // Expected value

Condition: Optimization other than for debugging at the time of compilation.

Workaround: Select [Optimize for Debugging] as the optimization level before compilation.

No.3 Source files with the same name

Applies to: All debugging tools for RL78, RX, RH850

Description: When two or more files with the same name exist in a load module being debugged, line addresses are not displayed correctly in the editor. Setting of events also does not work correctly.

Example:

C:\Work\CS+\ProjA\ProjA.mtpj\Src\main.c -> A.abs

C:\Work\CS+\ProjB\ProjB.mtpj\Src\main.c -> B.abs

This is a case where the above two load modules are being debugged simultaneously.

Note: Although multiple load modules are used in the above example, this restriction is also applicable to cases where a single load module is in use.

[Conditions] The relative paths to the files from the compilation directory are the same (including the filenames).

Building by CS+

Project file directory (*.mtpj) = compilation directory

Building by using a makefile

Current directory = compilation directory

Workaround: Source files with the same name can be distinguished in either of the following ways.

- a. Change the configuration of the folders so that the relative paths to the files from the compilation directory differ.

Before: ProjA\Src\main.c

ProjB\Src\main.c

After: ProjA\SrcA\main.c

ProjB\SrcB\main.c

With this change, the relative paths will be as follows.

"SrcA\main.c"

"SrcB\main.c"

- b. Change the names of the source files so that all of the files to be debugged have unique names.

Before: ProjA\Src\main.c

ProjB\Src\main.c

After: ProjA\Src\mainA.c

ProjB\Src\mainB.c

Notice

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